

Uniform Atomic Layer Deposition of Al₂O₃ on Graphene by Reversible Hydrogen Plasma Functionalization

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A novel method to form ultrathin, uniform Al₂O₃ layers on graphene using reversible hydrogen plasma functionalization followed by atomic layer deposition (ALD) is presented. ALD on pristine graphene is known to be a challenge due to the absence of dangling bonds, leading to non-uniform film coverage. We show that hydrogen plasma functionalization of graphene leads to uniform ALD of closed Al₂O₃ films down to 8-nm in thickness. Hall measurements (figure 1) and Raman spectroscopy reveal that the hydrogen plasma functionalization is reversible upon Al₂O₃ ALD and subsequent annealing at 400 °C, and in this way does not deteriorate the graphene's charge carrier mobility. This is in contrast with oxygen plasma functionalization, which can lead to a uniform 5-nm thick closed film, but which is not reversible and leads to a reduction of the charge carrier mobility. Density functional theory (DFT) calculations attribute the uniform growth on both H₂ and O₂ plasma functionalized graphene to the enhanced adsorption of Trimethylaluminum (TMA) on these surfaces. A DFT analysis of the possible reaction pathways for TMA precursor adsorption on hydrogenated graphene predicts a binding mechanism that cleans off the hydrogen functionalities from the surface, which explains the observed reversibility of the hydrogen plasma functionalization upon Al₂O₃ ALD.

Figures

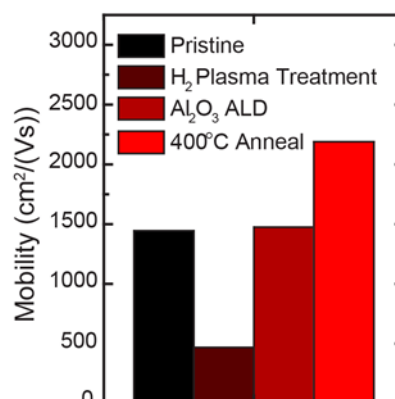


Figure 1: Charge carrier mobility of pristine graphene, H₂ plasma treated graphene, H₂ plasma treated graphene with 8 nm ALD Al₂O₃ on top, and after 400°C anneal.

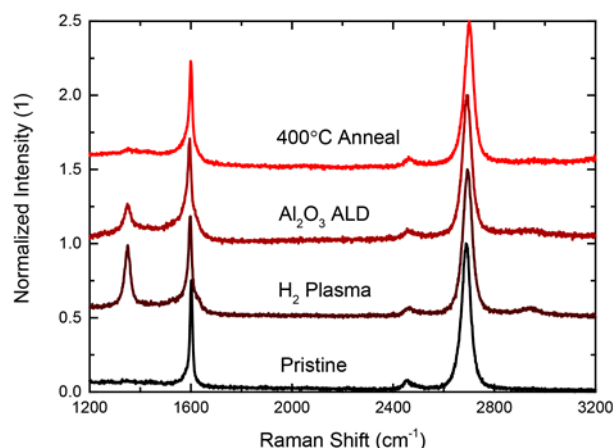


Figure 2: Raman spectrum of pristine graphene, H₂ plasma treated graphene, H₂ plasma treated graphene with 8 nm ALD Al₂O₃ on top, and after 400°C anneal.